

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Precision SMD TCXO









7.0 x 5.0 x 1.9mm

Moisture Sensitivity Level (MSL) – 3

FEATURES:

- Standard available frequencies: 10.00, 12.80, 19.20, 20.00, 25.00, 26.00, 30.72, 38.40 & 40.00MHz
- Standard LVCMOS Output
- Frequency stabilities to include ±100ppb over -40°C to +85°C, ±280ppb over -50°C to +90°C and ±500ppb over -55°C to +95°C operating temperature range
- Excellent Phase Noise, Harmonics and Spurious content
- Typical rms jitter of 400fs @ 40MHz carrier & 1.0ps @ 10MHz carrier over 12kHz to 20MHz BW

> APPLICATIONS:

- COTS Military Radios & other Communication Hardware
- WiMax,
- LTE, BTS
- CATV, LAN, LMDS
- GPS Tracking with Hold-Over accuracy
- Test & Measurement Equipment
- Point-to-Point communication networks

> STANDARD SPECIFICATIONS:

Maximum Rating

Parameters	Rating		
Storage Temperature Range	-55 to +125 °C		
Supply Voltage	-0.5 to 6V		
ESD, HBM/CDM/MM	4kV/2kV/200V		

Parameters	Minimum	Typical	Maximum	Units	Notes
Frequency R ange	10		40	MHz	
Standard Frequencies:	10 .00 , 12.8 0 , 19.2 0 , 20 .00 , 25 .00 , 26 .00 , 30.72, 38.4 0 , 40 .00		MHz		
Initial Frequency Tolerance (@+25°C) at shipping			±0.3	ppm	Relative to carrier
Frequency Stability Options					
-40 °C to +85 °C			±100	ppb	Option "1"
-50 °C to +90 °C			±280	ppb	Option "2" see note 1
-55 °C to +95 °C			±500	ppb	Option "5" see note 2
Frequency Stability vs. Supply Voltage Change (Vdd±5%):			±100	ppb	
Frequency Stability vs. Load Change (Load±5%):			±200	ppb	
Supply V oltage (Vdd):	+3.135	+3.3	+3.465	V	
Aging (first year @+25 °C):			±1.0	ppm	
Aging (20 years @+25 °C):		±3.0	±4.6	ppm	
		3.0	4.0		@10MHz carrier
Supply Current (Icc)(into 15pF load) :		5.5	7.0	mA	@4 0MHz carrier
CMOS Output	•			•	•
VOH	2.4			V	Load=15pF
V _{OE}			0.4	V	Load=15pF
Load:			15	pF	
Duty Cycle:	45		55	%	@(V OH- V OI)/2
Rise/Fall Time:			4	ns	Load=15pF
Waveform:		S quare Wave			
RMS Jitter (12kHz to 20MHz BW)	0.4		1.3	ps	Carrier dependent
			-95		Offset @10Hz
			-120]	Offset @100Hz
Phase Noise			-140	dBc/Hz	Offset @ 1k Hz
(10MHz carrier frequency @25°C):			-145	1	Offset @10 kHz
			-150	1	Offset @100kHz

^{*}Note 1: For 10.000MHz carrier, frequency stability of ±280ppb is only guaranteed over -45°C to +90°C operating temperature range.

^{*}Note 2: For 10.000MHz carrier, option "5" is not available.



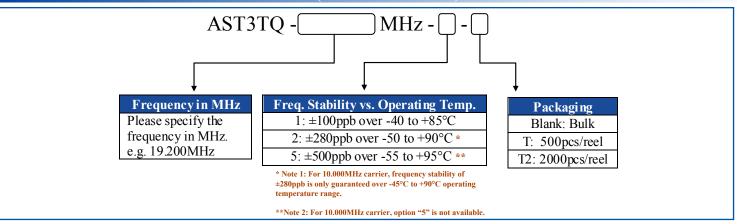
REVISED: 01.05.2017



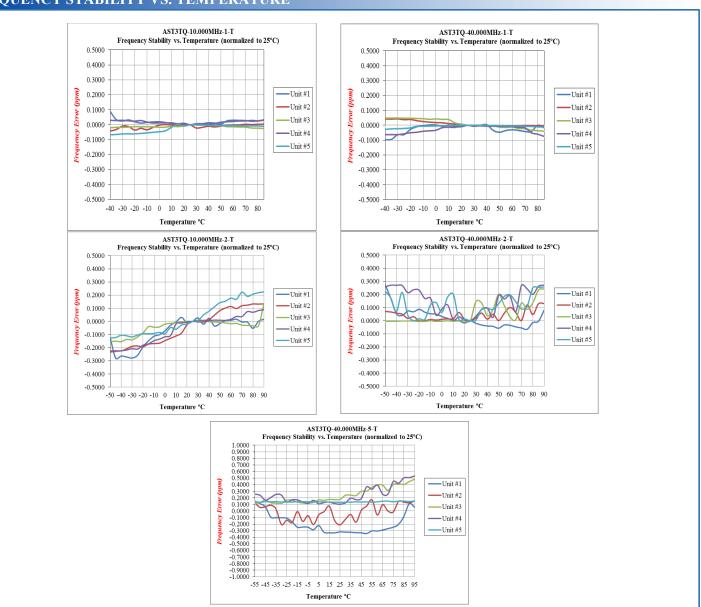


7.0 x 5.0 x 1.9mm

OPTIONS & PART IDENTIFICATION: (left blank if standard)



FREQUENCY STABILITY VS. TEMPERATURE

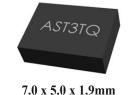




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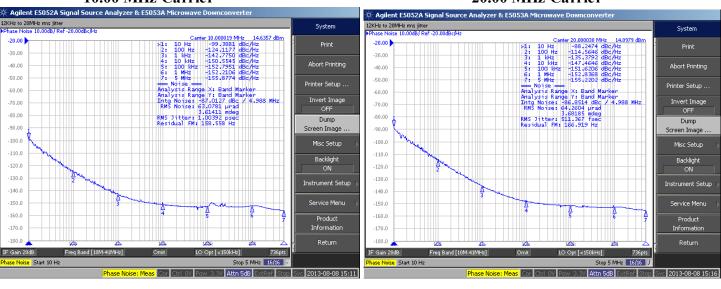




TYPICAL PHASE NOISE

10.00 MHz Carrier

20.00 MHz Carrier



40.00 MHz Carrier



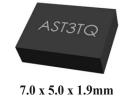
The Power of Linking Together

ABRACON LLC

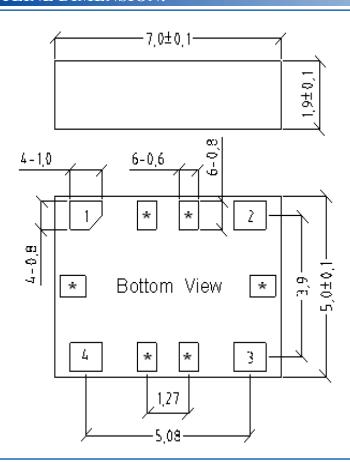
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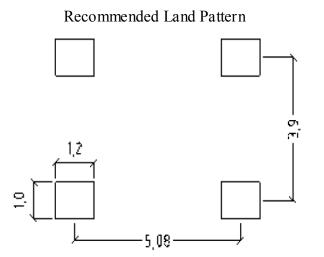
ABRACON IS ISO9001-2008 CERTIFIED





OUTLINE DIMENSION:

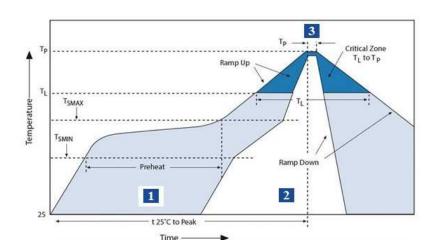




Pin	Function
1	NC
2	GND
3	Output
4	Vdd
*	For factory test only

Dimensions: mm

REFLOW PROFILE:



Zone Description		Temperature	Times	
1	Preheat	Tsmn ~ Tsmax 150°C ~ 200°C	60 ~ 120 sec.	
2	Reflow	T _L 220°C	60 ~ 150 sec.	
3	Peak heat	Tp 260°C	25 sec. MAX	







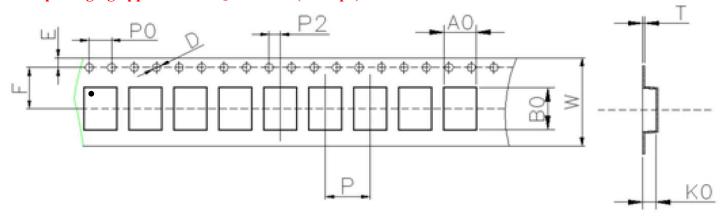


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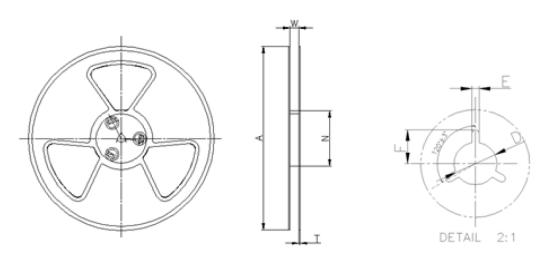
► TAPE & REEL:



MSL-3 packaging applies to MOQ=25 units (cut tape) & T and T2.



W	A0	В0	K0	P	F
16.0±0.3	5.7±0.15	7.6±0.15	2.4±0.15	8.0±0.1	7.5±0.1
E	D	P0	P2	T	
1.75±0.1	1.5+0.1/-0.0	4.0±0.1	2.0±0.1	0.3±0.05	



W	A	N	T	E	F	D
16.5±0.4	330±0.5	100±0.3	1.8±0.2	2.1±0.3	10.75±0.3	13.5+0.5/-0.2

Dimensions: mm

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